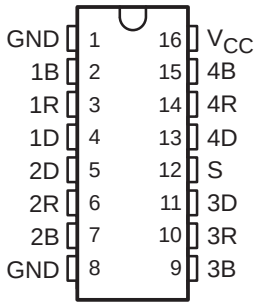
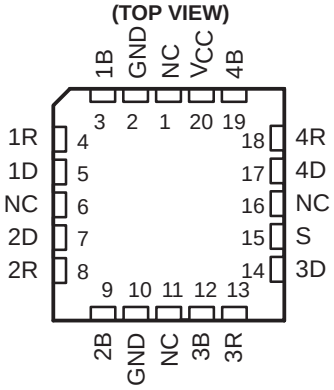
- **Single 5-V Supply**
- **High-Input-Impedance, High-Threshold Receivers**
- **Common Driver Strobe**
- **TTL-Compatible Driver and Strobe Inputs With Clamp Diodes**
- **High-Speed Operation**
- **100-mA Open-Collector Driver Outputs**
- **Four Independent Channels**
- **TTL-Compatible Receiver Output**

SN55138 . . . J OR W PACKAGE
SN75138 . . . D OR N PACKAGE
(TOP VIEW)



SN55138 . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

description

The SN55138 and SN75138 quadruple bus transceivers are designed for two-way data communication over single-ended transmission lines. Each of the four identical channels consists of a driver with TTL inputs and a receiver with a TTL output. The driver open-collector output is designed to handle loads up to 100-mA open collector. The receiver input is internally connected to the driver output, and has a high impedance to minimize loading of the transmission line. Because of the high driver-output current and the high receiver-input impedance, a very large number (typically hundreds) of transceivers may be connected to a single data bus.

The receiver design also features a threshold of 2.3 V (typical), providing a wider noise margin than would be possible with a receiver having the usual TTL threshold. A strobe turns off all drivers (high impedance) but does not affect receiver operation. These circuits are designed for operation from a single 5-V supply and include a provision to minimize loading of the data bus when the power-supply voltage is zero.

The SN55138 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN75138 is characterized for operation from 0°C to 70°C.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

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Function Tables

TRANSMITTING

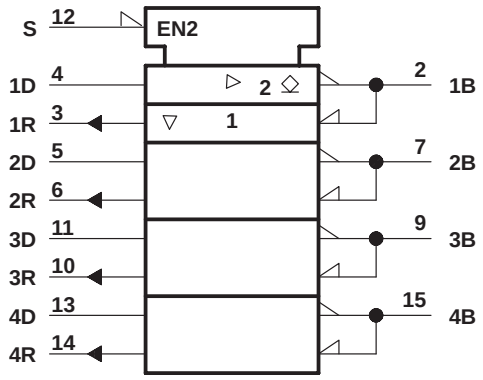
INPUTS		OUTPUTS	
S	D	B	R
L	H	L	H
L	L	H	L

RECEIVING

INPUTS			OUTPUT
S	B	D	R
H	H	X	L
H	L	X	H

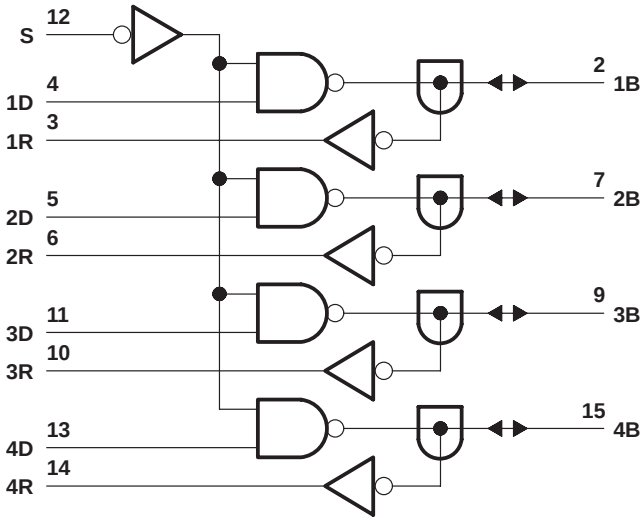
H = high level, L = low level, X = irrelevant

logic symbol†

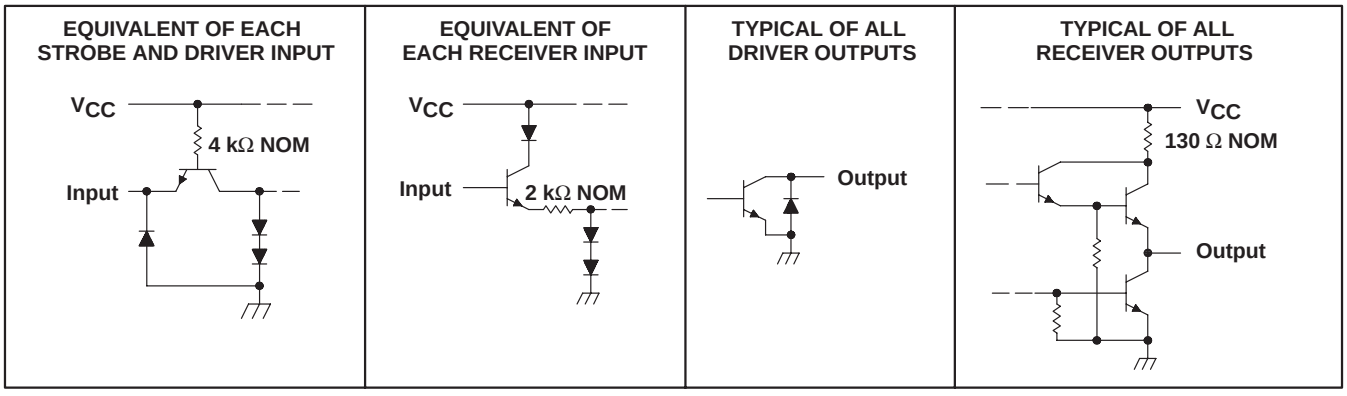


† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for D, J, N, and W packages.

logic diagram (positive logic)



schematics of inputs and outputs



absolute maximum ratings over operating free-air temperature (unless otherwise noted)†

Supply voltage, V_{CC} (see Note 1) . . . . . 7 V
Input voltage, V_I . . . . . 5.5 V
Driver off-state output voltage . . . . . 7 V
Low-level output current into the driver output . . . . . 150 mA
Continuous total dissipation . . . . . See Dissipation Rating Table
Operating free-air temperature range, T_A: SN55138 . . . . . –55°C to 125°C
SN75138 . . . . . 0°C to 70°C
Storage temperature range, T_{stg} . . . . . –65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds: D, N, or W package . . . . . 260°C
Case temperature for 60 seconds, T_C: FK package . . . . . 260°C
Lead temperature 1,6 mm (1/16 inch) from case for 60 seconds: J package . . . . . 300°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values are with respect to both ground terminals connected together.

DISSIPATION RATING TABLE

PACKAGE	$T_A \le 25°C$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25°C$	$T_A = 70°C$ POWER RATING	$T_A = 125°C$ POWER RATING
D	950 mW	7.6 mW/°C	608 mW	—
FK‡	1375 mW	11.0 mW/°C	880 mW	275 mW
J‡	1375 mW	11.0 mW/°C	880 mW	275 mW
N	1150 mW	9.2 mW/°C	736 mW	—
W	1000 mW	8.0 mW/°C	640 mW	200 mW

‡ In the FK and J packages, the SN55138 chip is alloy mounted.

recommended operating conditions

		SN55138			SN75138			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
Supply voltage, V_{CC}		4.5		5.5	4.75	5	5.25	V
High-level input voltage, V_{IH}	Driver or strobe	2			2			V
	Receiver	3.2			2.9			
Low-level input voltage, V_{IL}	Driver or strobe			0.8			0.8	V
	Receiver			1.5			1.8	
High-level output current, I_{OH}	Receiver output			–400			–400	μA
Low-level output current, I_{OL}	Driver output			100			100	mA
	Receiver output			16			16	
Operating free-air temperature, T_A		–55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			TEST CONDITIONS†		SN55138			SN75138			UNIT
					MIN	TYP‡	MAX	MIN	TYP‡	MAX	
V_{IK}	Input clamp voltage	Driver or strobe	V_{CC} = MIN,	I_I = –12 mA			–1.5			–1.5	V
V_{OH}	High-level output voltage	Receiver	V_{CC} = MIN, $V_{IL(R)}$ = V_{IL} max,	$V_{IH(S)}$ = 2 V, I_{OH} = –400 μA	2.4	3.5		2.4	3.5		V
V_{OL}	Low-level output voltage	Driver	V_{CC} = MIN, $V_{IL(S)}$ = 0.8 V,	$V_{IH(D)}$ = 2 V, I_{OL} = 100 mA			0.45			0.45	V
		Receiver	V_{CC} = MIN, $V_{IH(S)}$ = 2 V,	$V_{IH(R)}$ = V_{IH} min, I_{OL} = 16 mA			0.4			0.4	
I_I(max)	Input current at maximum input voltage	Driver or strobe	V_{CC} = MAX,	V_I = V_{CC}			1			1	mA
I_{IH}	High-level input current	Driver or strobe	V_{CC} = MAX,	V_I = 2.4 V			40			40	μA
		Receiver	V_{CC} = 5 V, $V_{I(S)}$ = 2 V	$V_{I(R)}$ = 4.5 V,		25	300		25	300	
I_{IL}	Low-level input current	Driver or strobe	V_{CC} = MAX,	V_I = 0.4 V		–1	–1.6		–1	–1.6	mA
		Receiver	V_{CC} = MAX, $V_{I(S)}$ = 2 V	$V_{I(R)}$ = 0.45 V,			–50			–50	μA
$I_{I(off)}$	Input current with power off	Receiver	V_{CC} = 0,	V_I = 4.5 V		1.1	1.5		1.1	1.5	mA
I_{OS}	Short-circuit output current§	Receiver	V_{CC} = MAX		–20		–55	–18		–55	mA
I_{CC}	Supply current	All driver outputs low	V_{CC} = MAX, $V_{I(S)}$ = 0.8 V	$V_{I(D)}$ = 2 V,		50	65		50	65	mA
		All driver outputs high	V_{CC} = MAX, $V_{I(S)}$ = 2 V, Receiver outputs open	$V_{I(R)}$ = 3.5 V,		42	55		42	55	

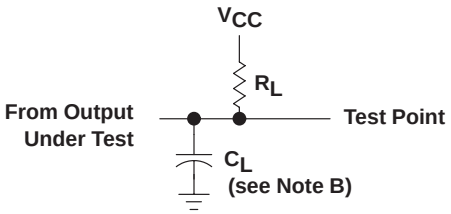
† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. Parenthetical letters D, R, and S used with V_I refer to the driver input, receiver input, and strobe input, respectively.
‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.
§ Not more than one output should be shorted at a time.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

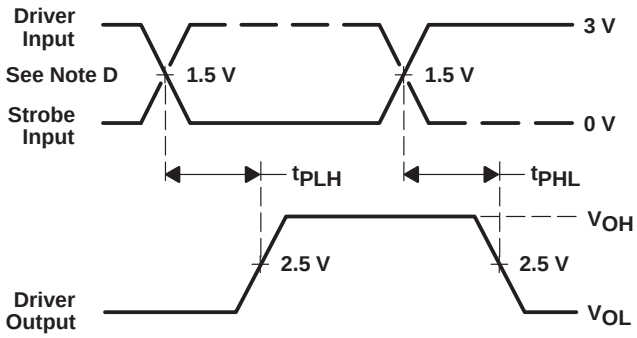
PARAMETER¶	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS		MIN	TYP	MAX	UNIT
t_{PLH}	Driver	Driver	C_L = 50 pF, R_L = 50 Ω,	See Figure 1		15	24	ns
t_{PHL}						14	24	
t_{PLH}	Strobe	Driver				18	28	ns
t_{PHL}						22	32	
t_{PLH}	Receiver	Receiver	C_L = 15 pF R_L = 400 Ω,	See Figure 2		7	15	ns
t_{PHL}						8	15	

¶ t_{PLH} = propagation delay time, low- to high-level output
t_{PHL} = propagation delay time, high- to low-level output

PARAMETER MEASUREMENT INFORMATION



TEST CIRCUIT

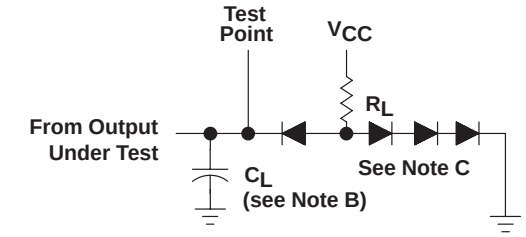


VOLTAGE WAVEFORMS

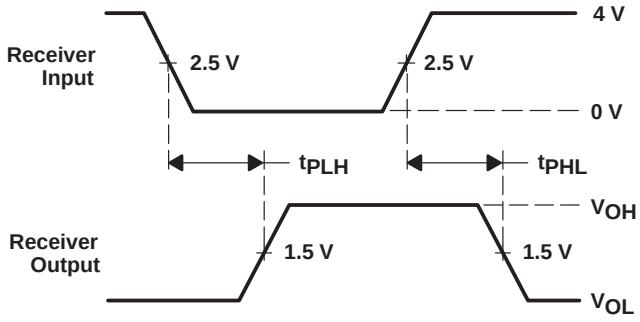
NOTES: A. Input pulses are supplied by generators having the following characteristics: t_W = 100 ns, PRR ≤ 1 MHz, t_r ≤ 10 ns, t_f ≤ 10 ns, $Z_O \approx 50\ \Omega$.
B. C_L includes probe and jig capacitance.
C. All diodes are 1N916 or 1N3064.
D. When testing driver input (solid line) strobe must be low; when testing strobe input (dashed line) driver input must be high.

Figure 1. Propagation Delay Times From Data and Strobe Inputs

PARAMETER MEASUREMENT INFORMATION



TEST CIRCUIT



VOLTAGE WAVEFORMS

NOTES: A. Input pulses are supplied by generators having the following characteristics: t_W = 100 ns, PRR ≤ 1 MHz, t_r ≤ 10 ns, t_f ≤ 10 ns, $Z_O \approx 50\ \Omega$.
B. C_L includes probe and jig capacitance.
C. All diodes are 1N916 or 1N3064.
D. When testing driver input (solid line) strobe must be low; when testing strobe input (dashed line) driver input must be high.

Figure 2. Propagation Delay Times From Receiver Input

TYPICAL CHARACTERISTICS†

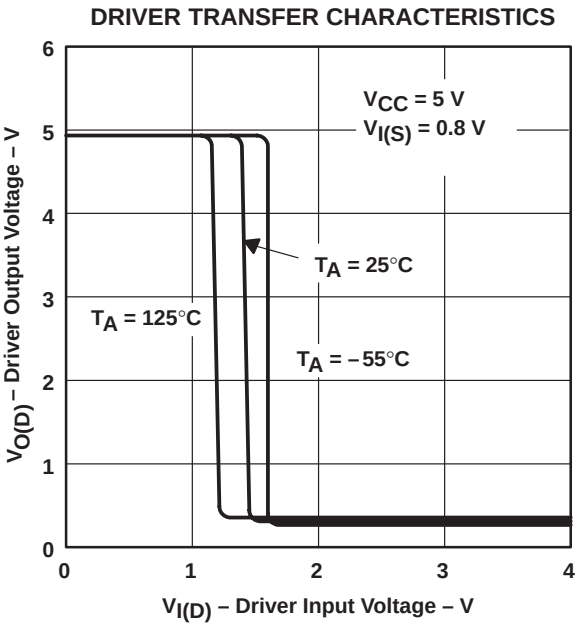


Figure 3

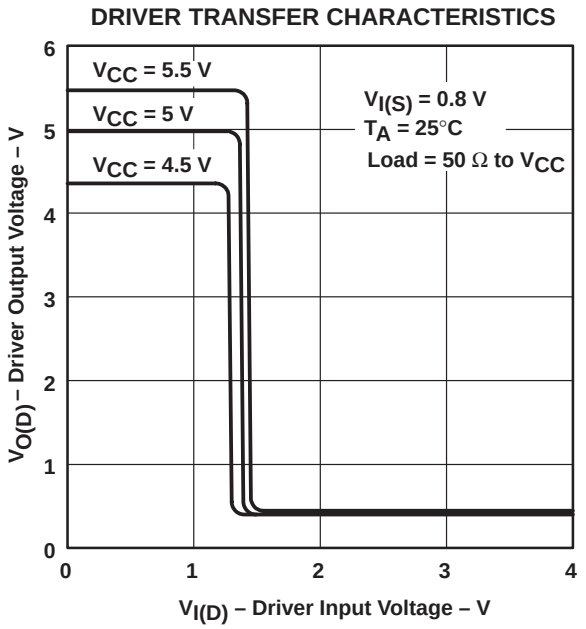


Figure 4

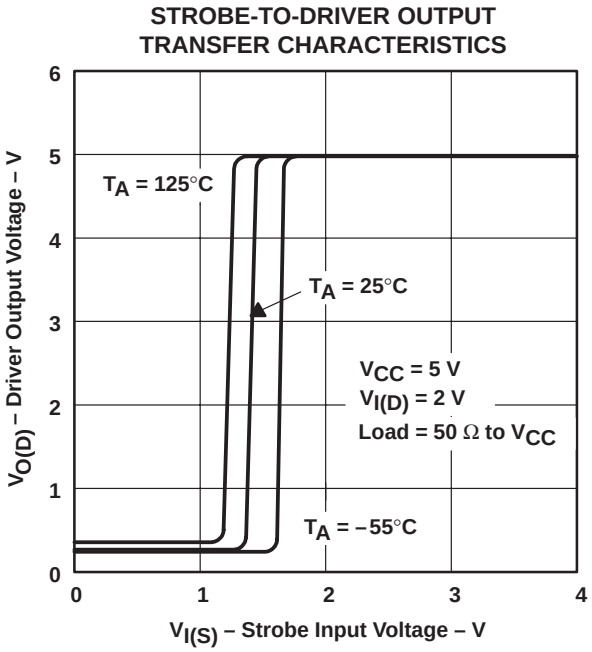


Figure 5

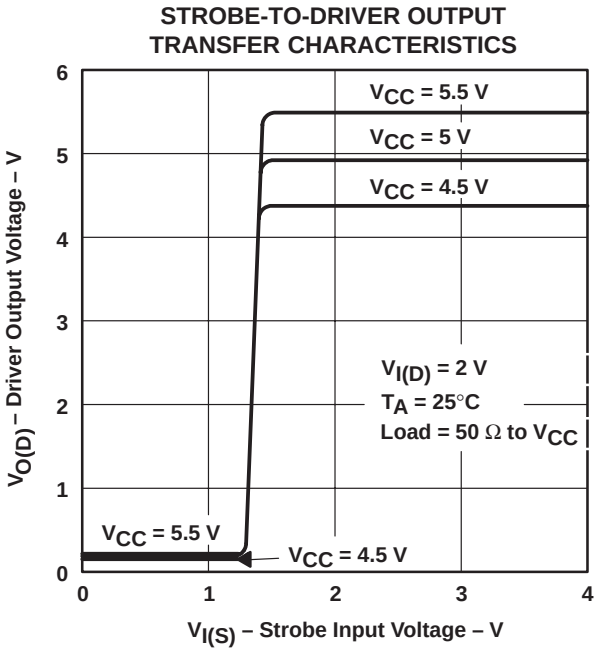


Figure 6

† Data for temperatures below 0°C and above 70°C is applicable to SN55138 circuits only.

TYPICAL CHARACTERISTICS†

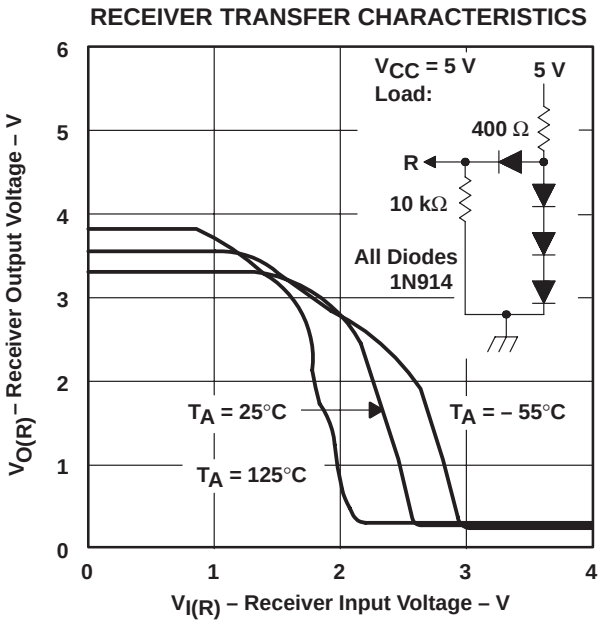


Figure 7

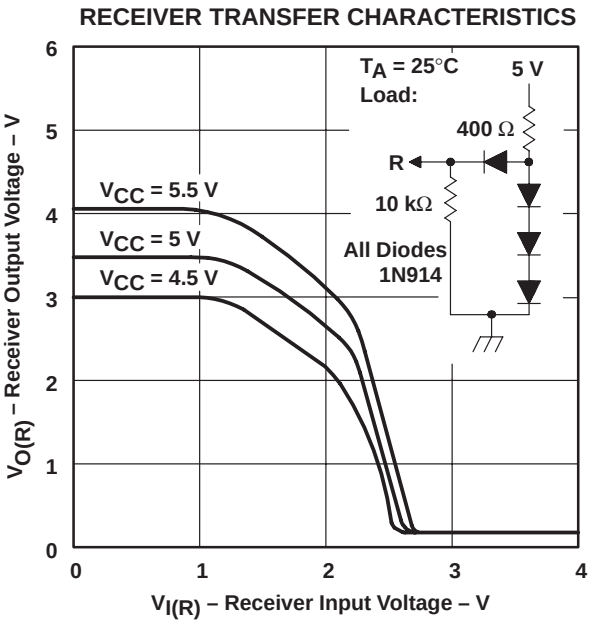


Figure 8

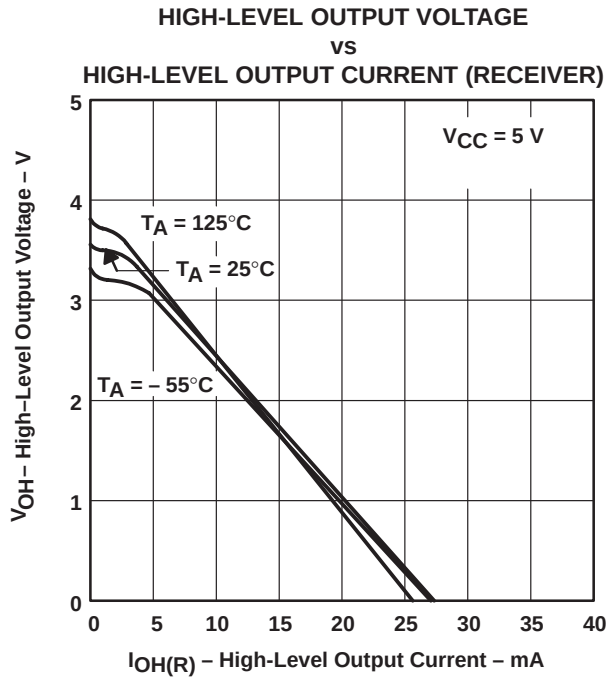


Figure 9

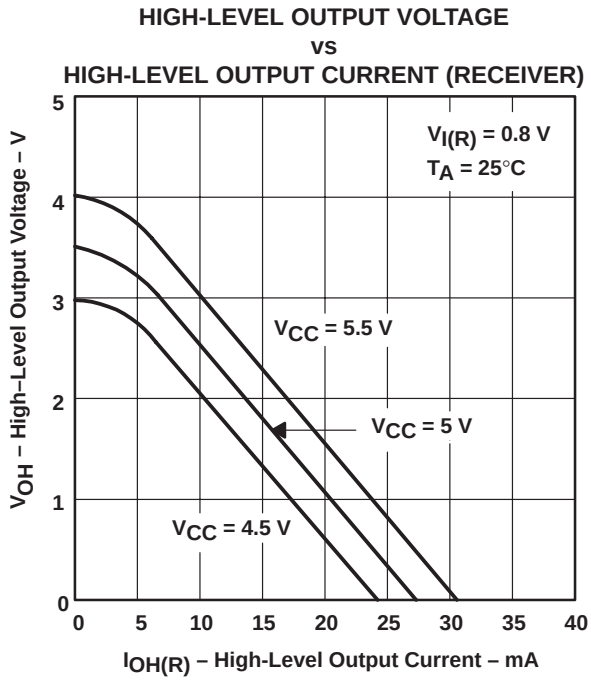


Figure 10

† Data for temperatures below 0°C and above 70°C is applicable to SN55138 circuits only.

TYPICAL CHARACTERISTICS†

LOW-LEVEL OUTPUT VOLTAGE vs LOW-LEVEL OUTPUT CURRENT (RECEIVER)

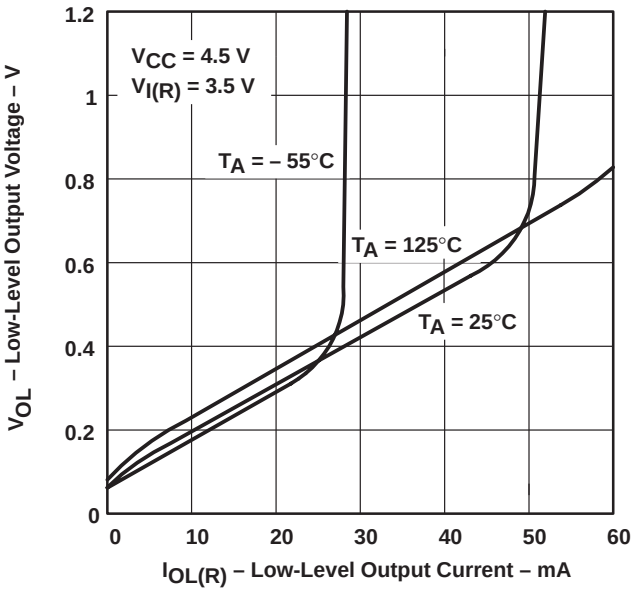


Figure 11

LOW-LEVEL OUTPUT VOLTAGE vs LOW-LEVEL OUTPUT CURRENT (DRIVER)

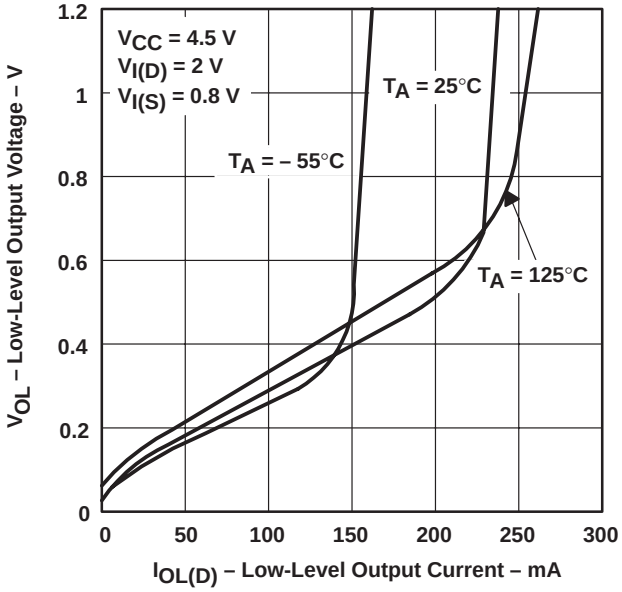


Figure 12

RECEIVER INPUT CURRENT vs RECEIVER INPUT VOLTAGE

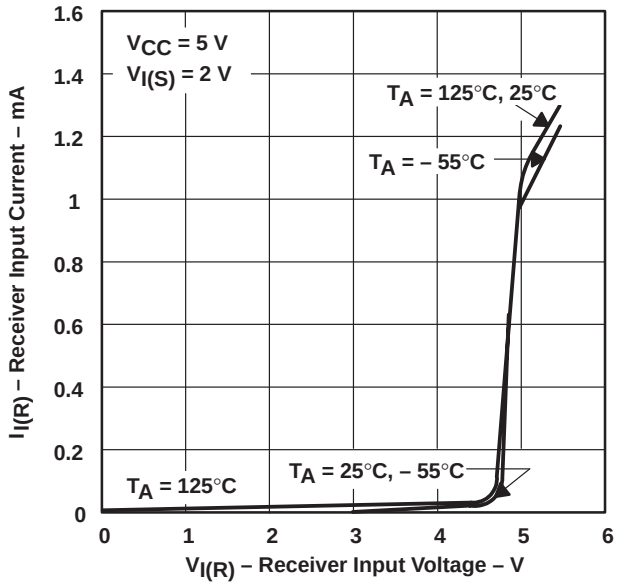


Figure 13

RECEIVER INPUT CURRENT vs RECEIVER INPUT VOLTAGE

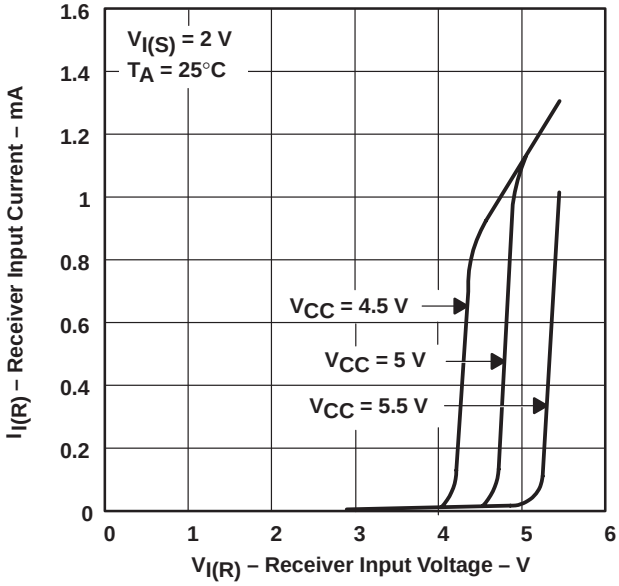


Figure 14

† Data for temperatures below 0°C and above 70°C is applicable to SN55138 circuits only.

TYPICAL CHARACTERISTICS†

SUPPLY CURRENT vs SUPPLY VOLTAGE (ALL DRIVER OUTPUTS LOW)

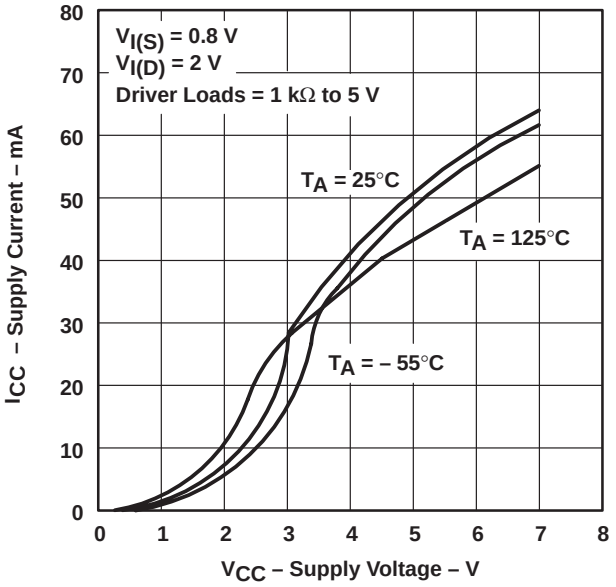


Figure 15

SUPPLY CURRENT vs SUPPLY VOLTAGE

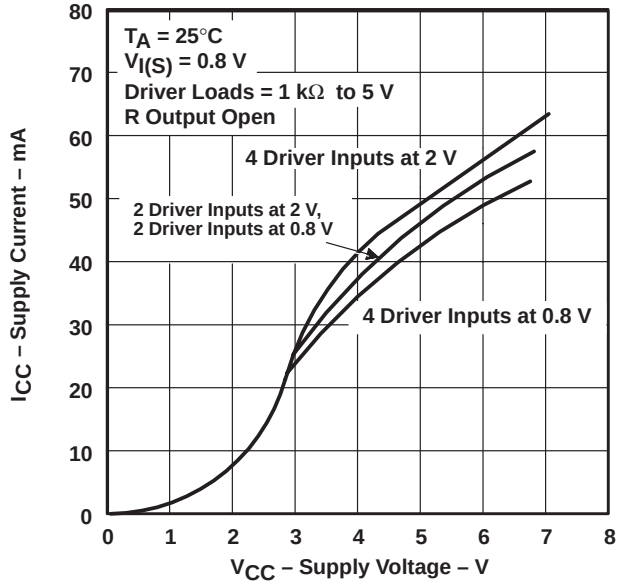


Figure 16

PROPAGATION DELAY TIMES vs FREE-AIR TEMPERATURE

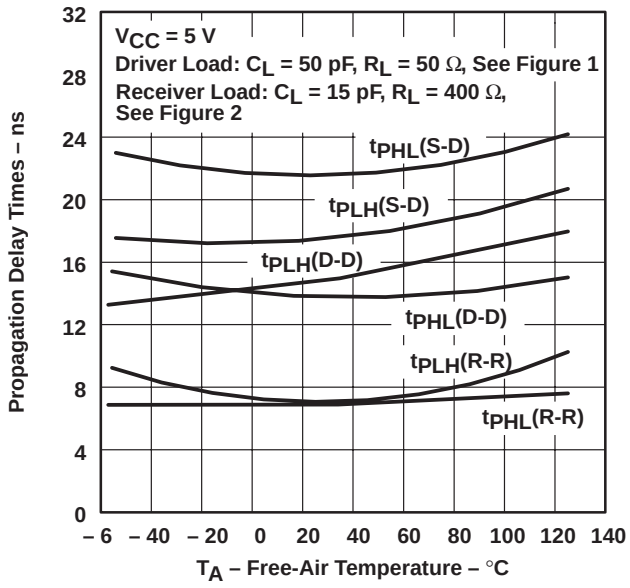


Figure 17

PROPAGATION DELAY TIMES vs SUPPLY VOLTAGE

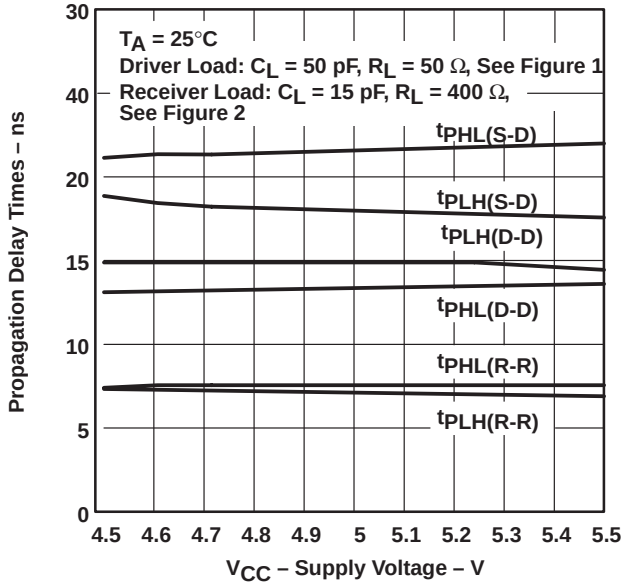


Figure 18

† Data for temperatures below 0°C and above 70°C is applicable to SN55138 circuits only.

TYPICAL CHARACTERISTICS

DRIVER
PROPAGATION DELAY TIMES
vs
LOAD CAPACITANCE

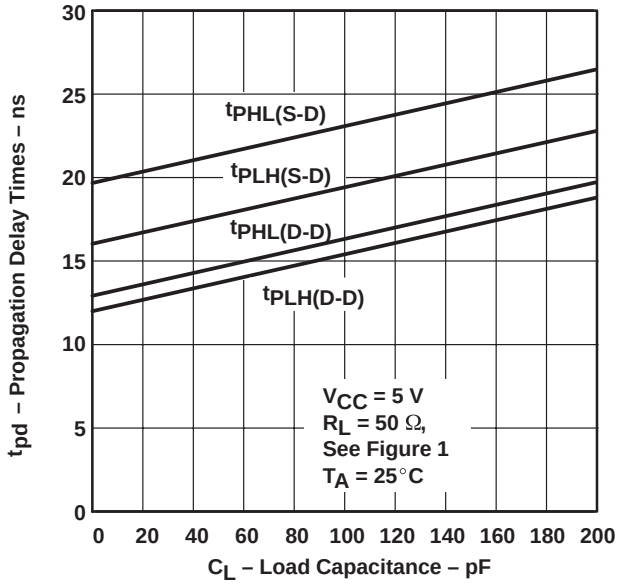


Figure 19

RECEIVER
PROPAGATION DELAY TIMES
vs
LOAD CAPACITANCE

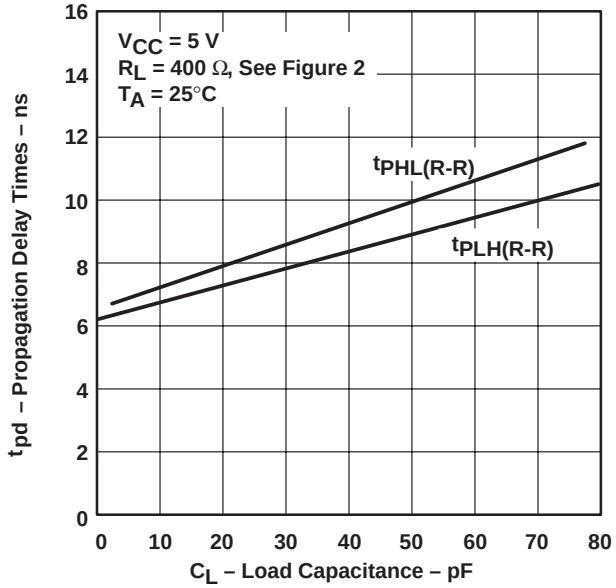
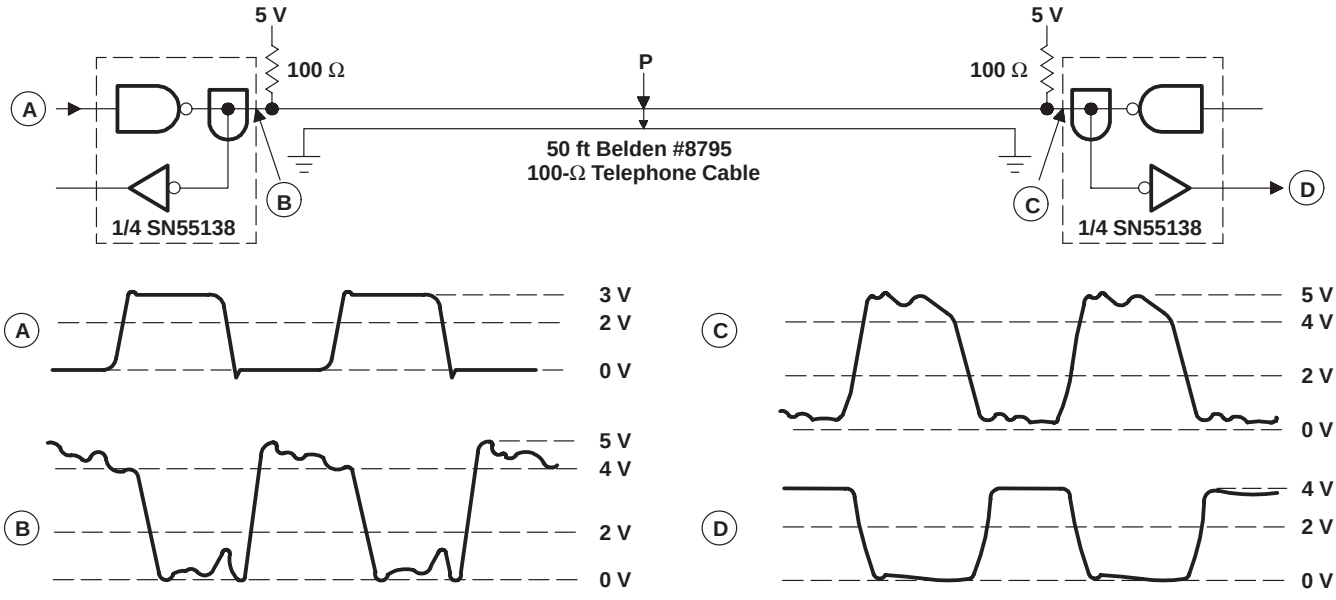


Figure 20

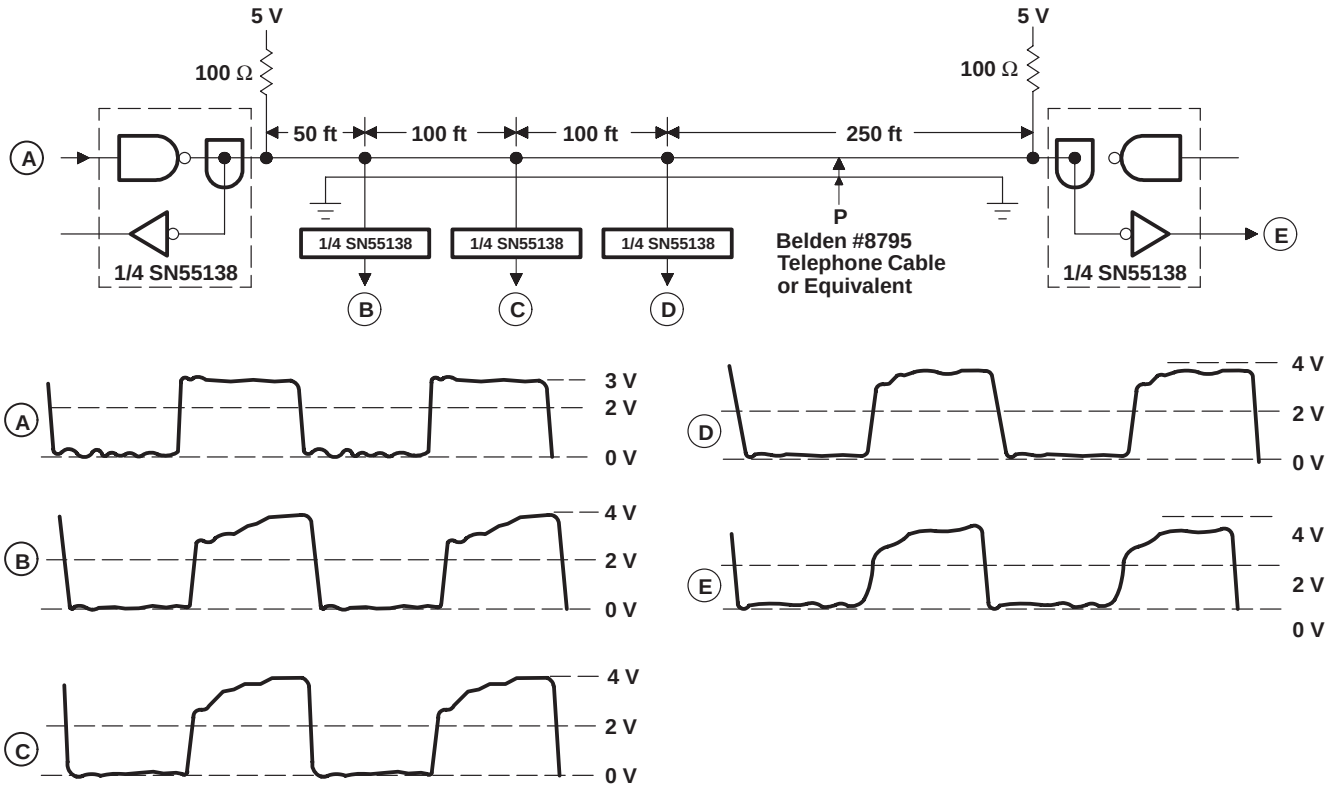
APPLICATION INFORMATION



TYPICAL VOLTAGE WAVEFORMS

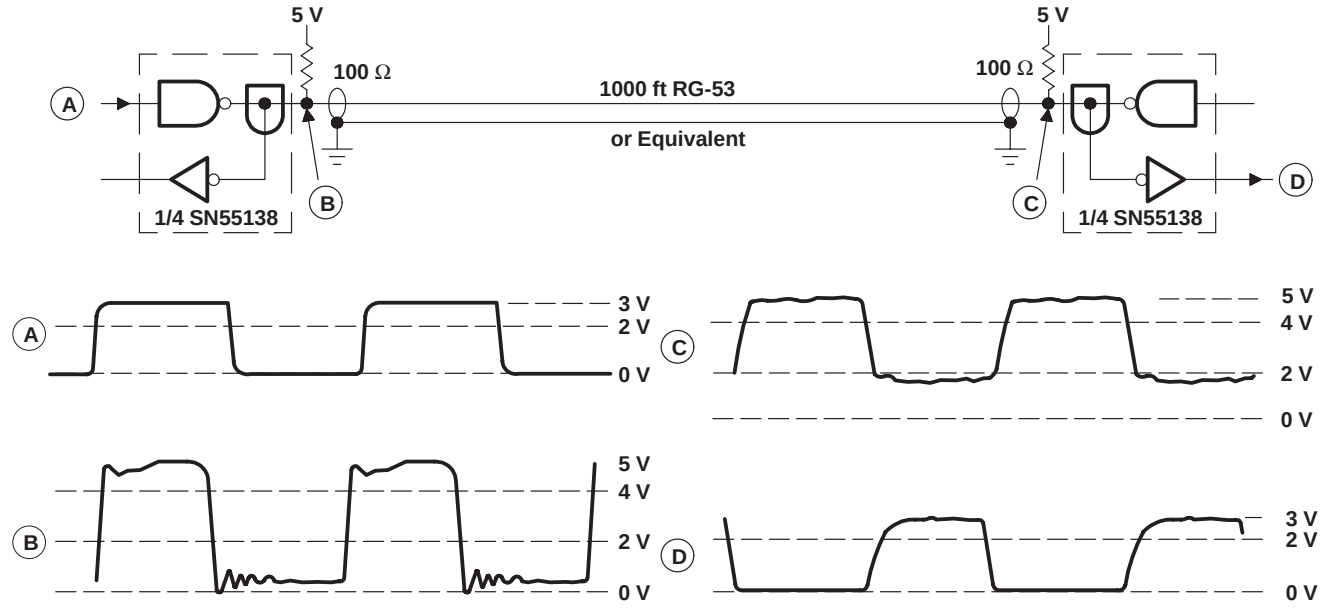
Figure 21. Point-to-Point Communication Over 50 Feet of Twisted Pair at 5 MHz

APPLICATION INFORMATION



TYPICAL VOLTAGE WAVEFORMS

Figure 22. Party-Line Communication on 500 Feet of Twisted Pair at 1 MHz



TYPICAL VOLTAGE WAVEFORMS

Figure 23. Point-to-Point Communication Over 1000 Feet of Coaxial Cable at 1 MHz

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
SN75138D	Active	Production	SOIC (D) | 16	40 | TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	SN75138
SN75138D.A	Active	Production	SOIC (D) | 16	40 | TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	SN75138
SN75138DR	Active	Production	SOIC (D) | 16	2500 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	SN75138
SN75138DR.A	Active	Production	SOIC (D) | 16	2500 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	SN75138
SN75138N	Active	Production	PDIP (N) | 16	25 | TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN75138N
SN75138N.A	Active	Production	PDIP (N) | 16	25 | TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN75138N
SN75138NSR	Active	Production	SOP (NS) | 16	2000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	SN75138
SN75138NSR.A	Active	Production	SOP (NS) | 16	2000 | LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	SN75138

(1) **Status:** For more details on status, see our product life cycle.

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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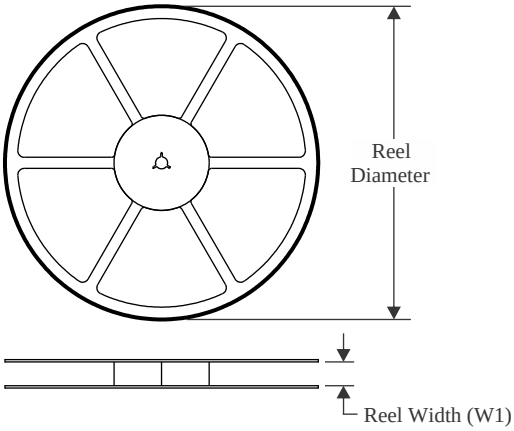
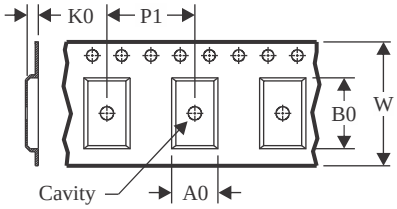
TAPE AND REEL INFORMATION

REEL DIMENSIONS

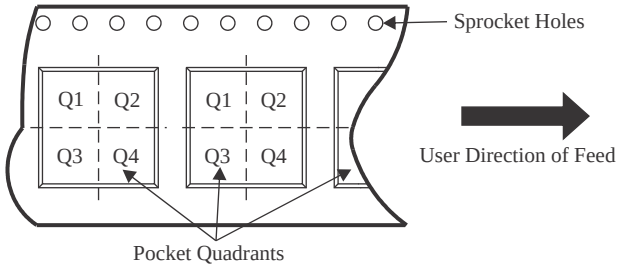


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

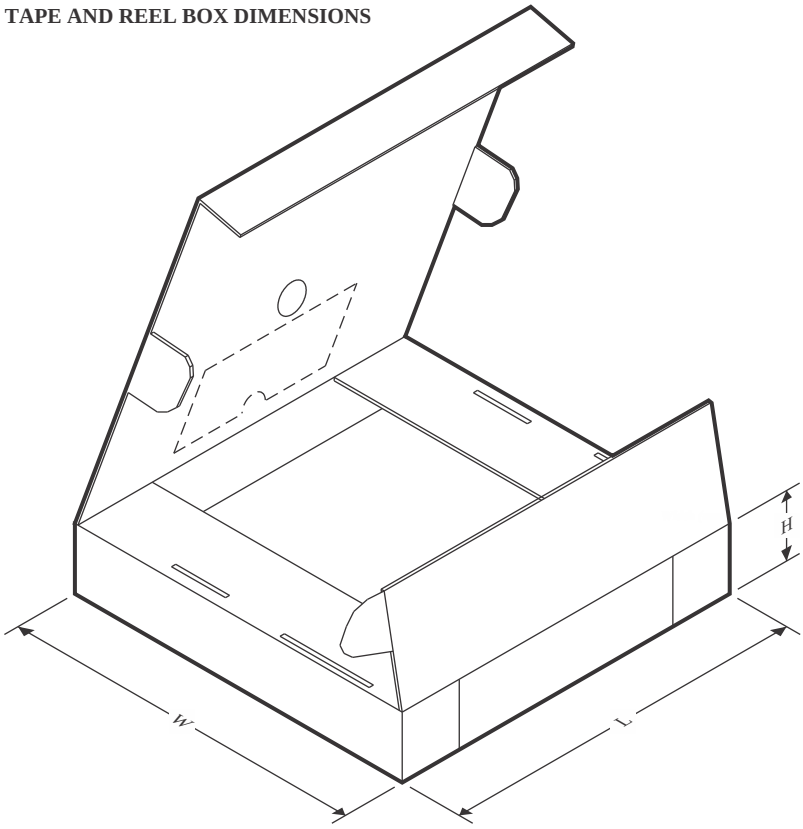
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN75138DR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN75138NSR	SOP	NS	16	2000	330.0	16.4	8.1	10.4	2.5	12.0	16.0	Q1

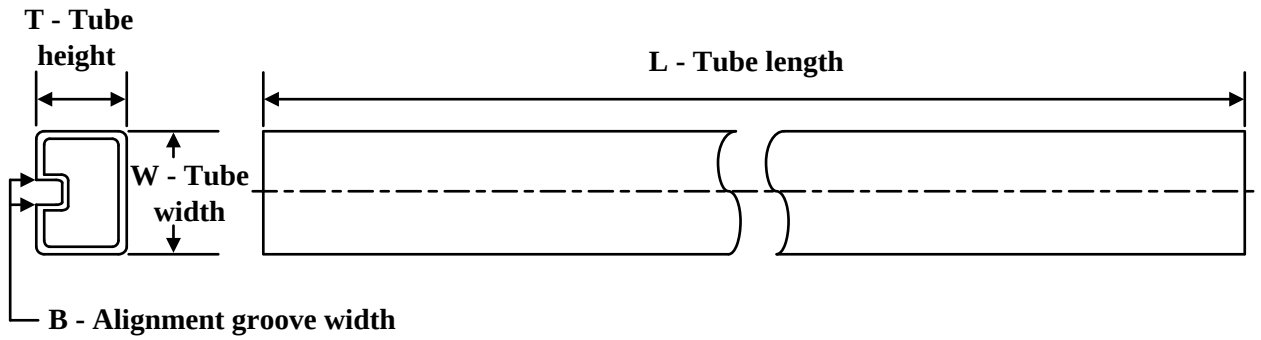
TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

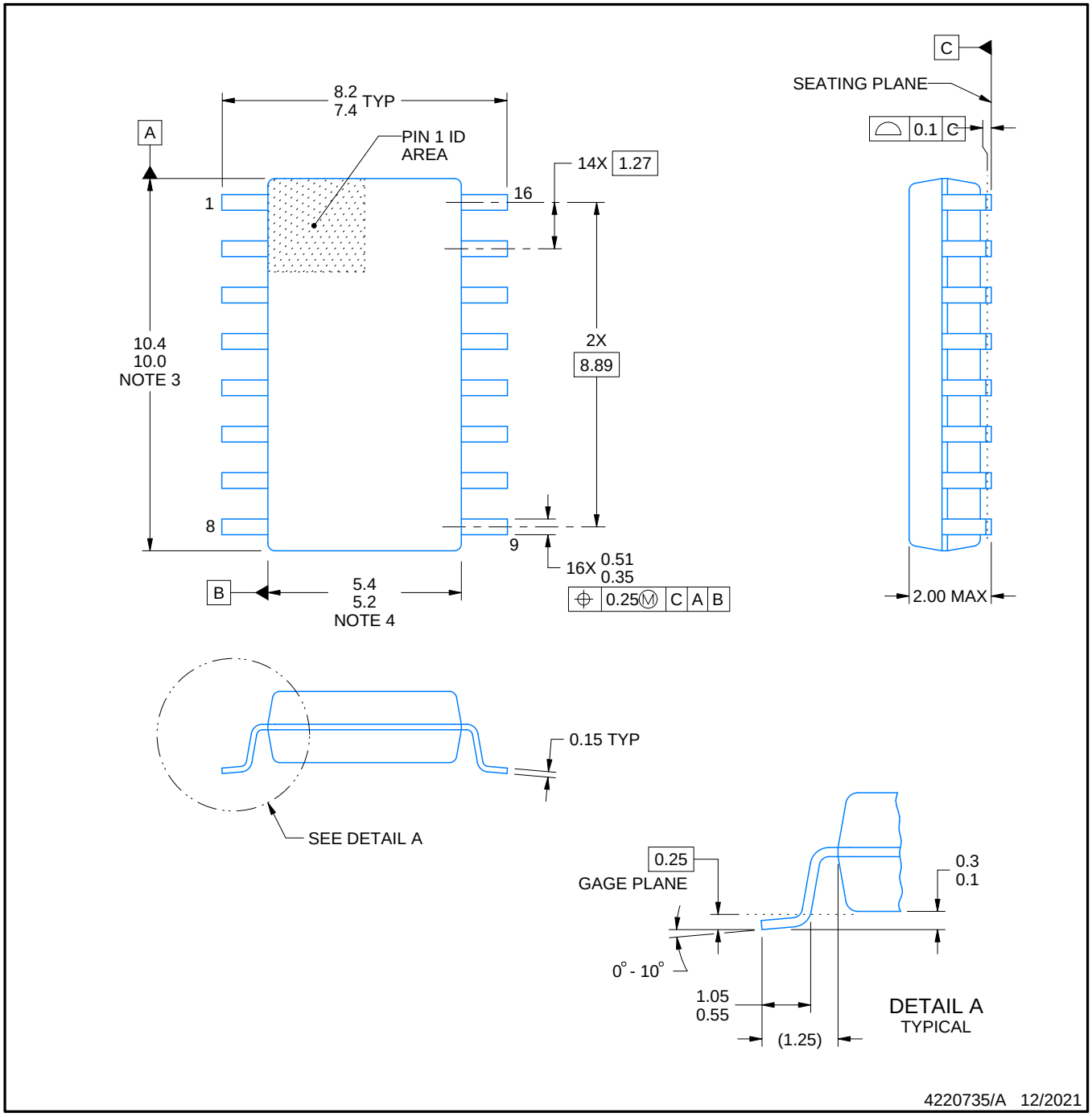
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN75138DR	SOIC	D	16	2500	353.0	353.0	32.0
SN75138NSR	SOP	NS	16	2000	353.0	353.0	32.0

TUBE



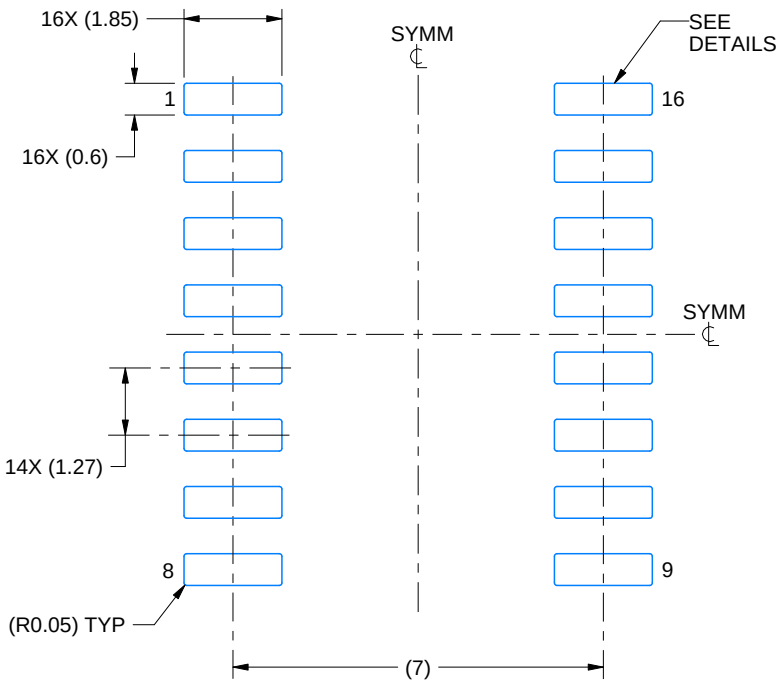
*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
SN75138D	D	SOIC	16	40	507	8	3940	4.32
SN75138D.A	D	SOIC	16	40	507	8	3940	4.32
SN75138N	N	PDIP	16	25	506	13.97	11230	4.32
SN75138N.A	N	PDIP	16	25	506	13.97	11230	4.32

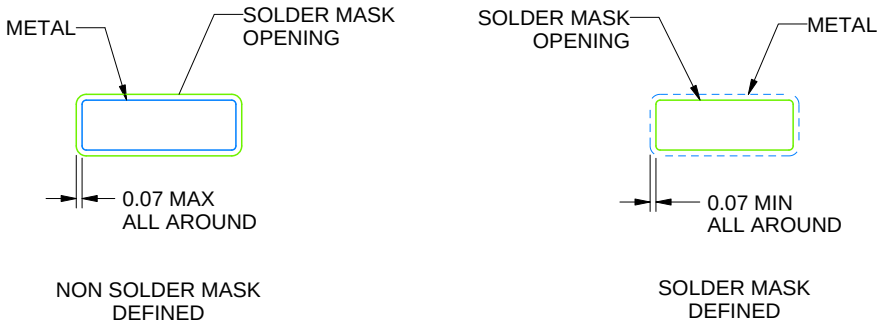


NOTES:

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.



LAND PATTERN EXAMPLE
SCALE:7X



SOLDER MASK DETAILS

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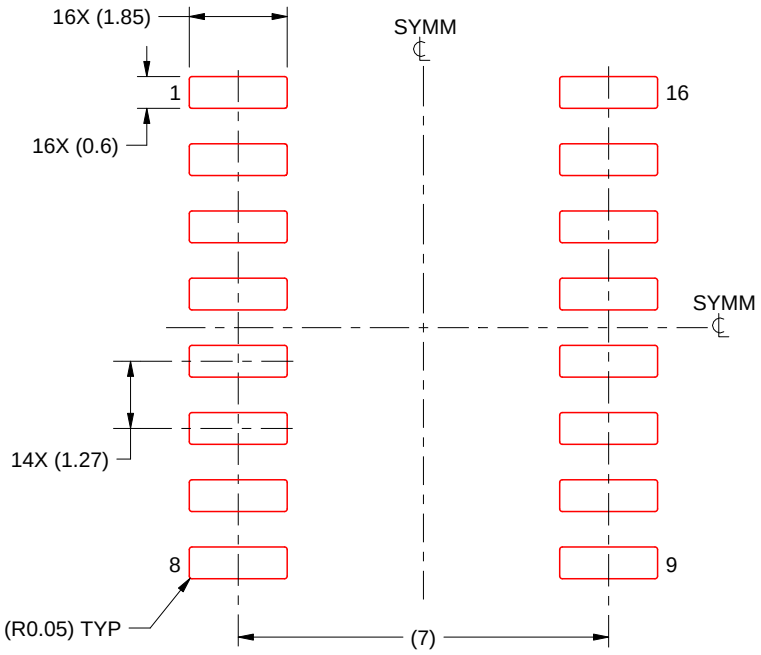
NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:7X

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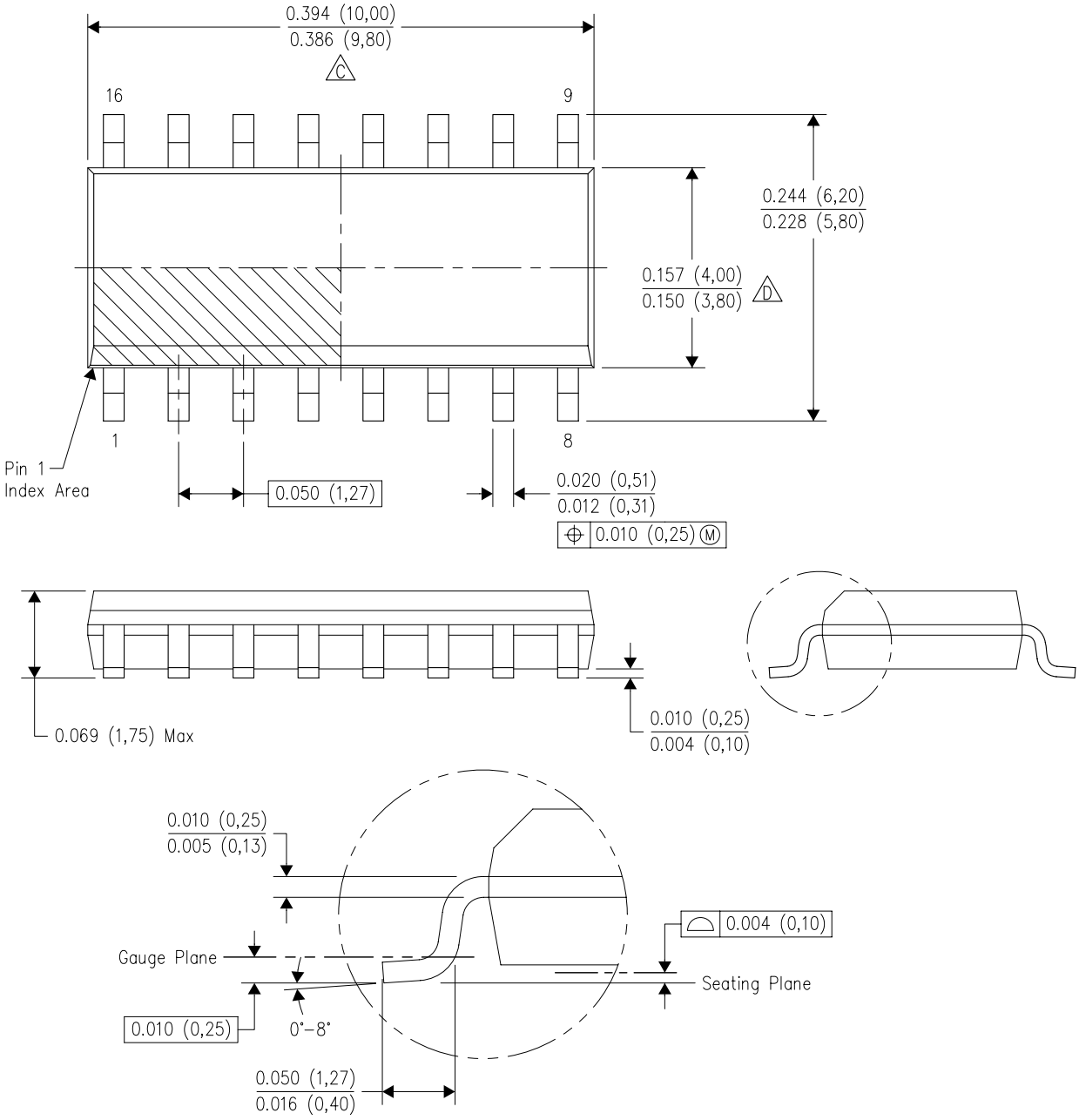
NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

D (R–PDSO–G16) PLASTIC SMALL OUTLINE

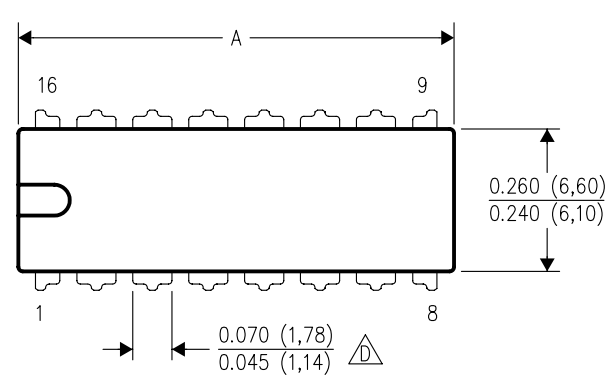


NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
E. Reference JEDEC MS–012 variation AC.

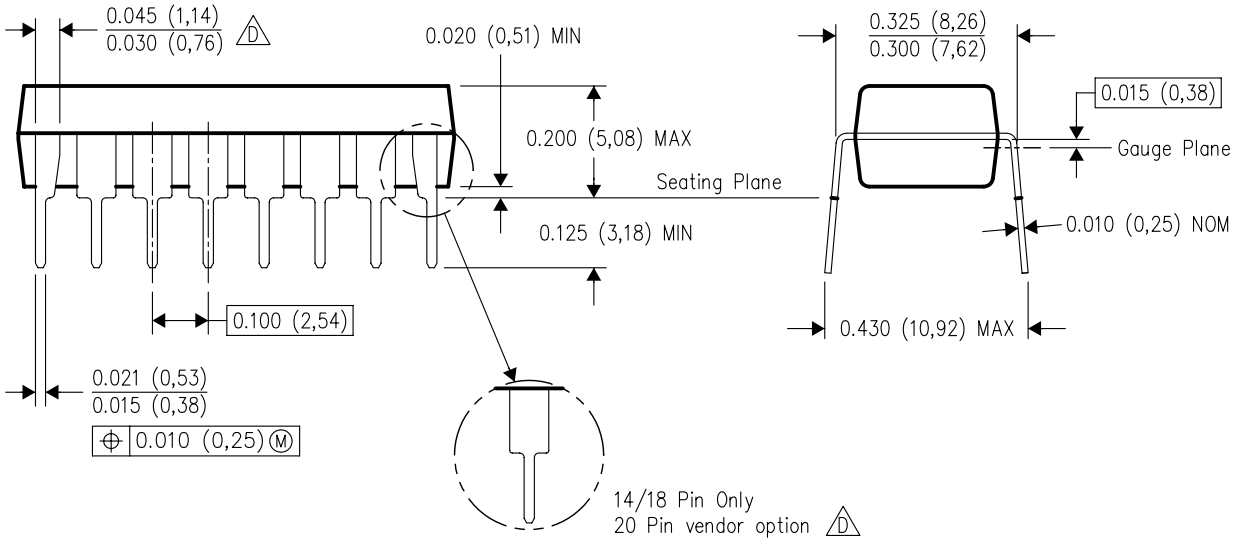
N (R–PDIP–T**)

PLASTIC DUAL–IN–LINE PACKAGE

16 PINS SHOWN



DIM \ PINS **	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
MS–001 VARIATION (C)	AA	BB	AC	AD



4040049/E 12/2002

NOTES:
A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.
C. Falls within JEDEC MS–001, except 18 and 20 pin minimum body length (Dim A).
D. The 20 pin end lead shoulder width is a vendor option, either half or full width.

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